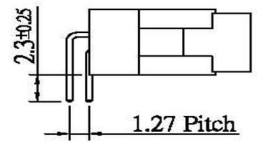
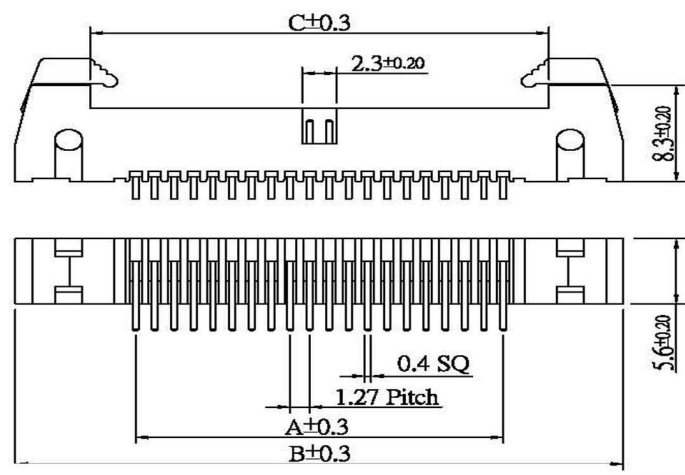


P.C.Board Layout

Contract:  
 Contact:Brass.  
 Insuiator:LCP.  
 Finish:Gold flash plated over nickel.



Circuits	Dimension		
	A	B	C
6	2.54	18.31	8.46
10	5.08	20.85	11.00
12	6.35	22.12	12.27
14	7.62	23.39	13.54
16	8.89	24.66	14.81
20	11.43	27.20	17.35
26	15.24	31.01	21.16
30	17.78	33.55	23.70
34	20.32	36.09	26.24
40	24.13	39.90	30.05
44	26.67	42.44	32.59
50	30.48	46.25	36.40
60	36.83	52.60	42.75
64	39.37	55.14	45.29
66	40.64	56.41	46.56
68	41.91	57.68	47.83

Specification:  
 Current Rating :1A Max  
 Voltage Rating :250V AC For 1 Min  
 Operating Temp : -40°C~+105°C  
 Insulation Resistance:1000MΩ Min  
 Dielectric Withstanding Voltage :500V AC For 1Min  
 Contact Resistance:20mΩ Max

RoHS Compliant	<b>HSM</b> 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 BETTY		TOLERANCE 容許公差 .0 ± .00 ± ANG. ±
DWG. 製圖 BETTY	SCALE 比例 參考	PART NAME 品名 SHROUDED HEADER 1.27mmX1.27mm XYP 90° GOLD FLASH PLATING BLACK COLOR W/O LOCATING PEG ROHS
DATE 制表日 2008/08/01	UNIT 單位 MM	SIZE. 紙張尺寸 A 4
PAGE 張數 1 OF 1	REV. 版次 A	PART NO. 料號 C3505-XXRNGB00R